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Date	I.Umezaki	22-May.-2009

CM800E4C-66H

HIGH POWER SWITCHING USE
INSULATED TYPE

3rd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) MODULES

CM800E4C-66H



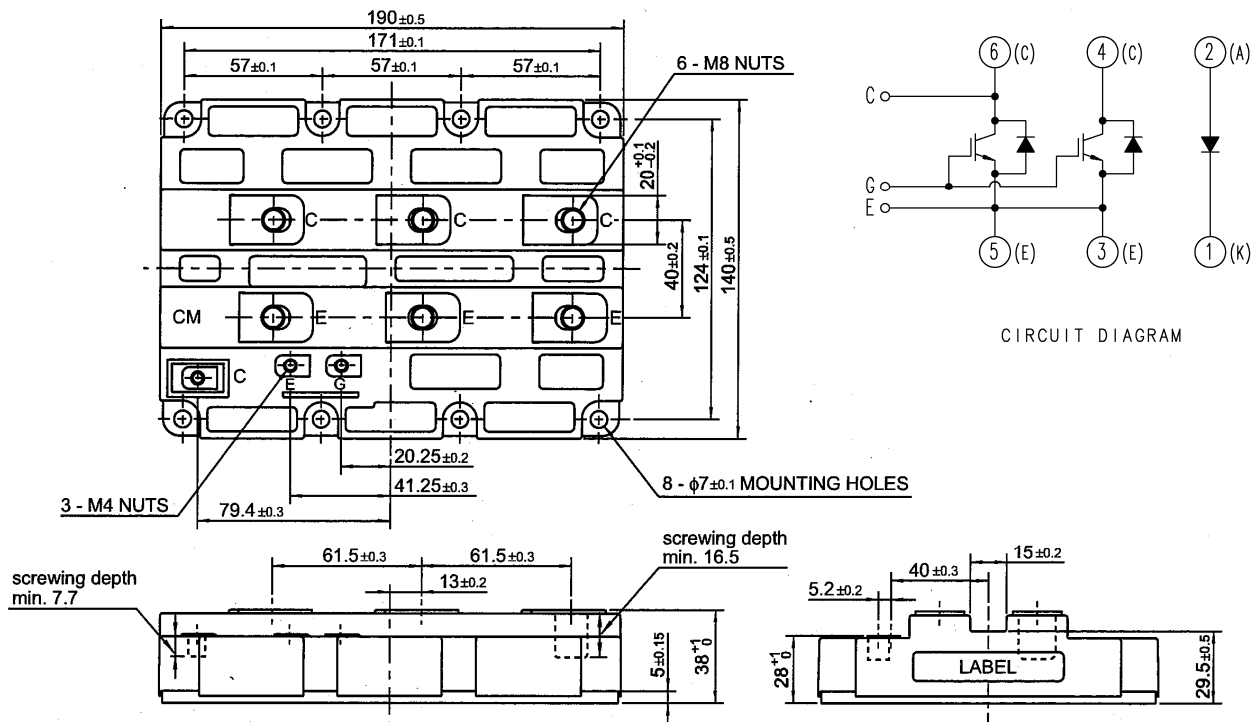
- I_C 800 A
- V_{CES} 3300 V
- 1-element in a Pack (for brake chopper)
- Insulated Type
- AISiC Baseplate

APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
V_{CES}	Collector-emitter voltage	$V_{GE} = 0V, T_j = 25^\circ C$	3300	V
V_{GES}	Gate-emitter voltage	$V_{CE} = 0V, T_j = 25^\circ C$	± 20	V
I_C	Collector current	DC, $T_c = 100^\circ C$	800	A
I_{CM}		Pulse (Note 1)	1600	A
I_E	Emitter current (Note 2)	DC	800	A
I_{EM}		Pulse (Note 1)	1600	A
P_c	Maximum power dissipation (Note 3)	$T_c = 25^\circ C$, IGBT part	9600	W
V_{iso}	Isolation voltage	RMS, sinusoidal, $f = 60Hz, t = 1 \text{ min.}$	6000	V
T_j	Junction temperature		$-40 \sim +150$	$^\circ C$
T_{op}	Operating temperature		$-40 \sim +125$	$^\circ C$
T_{stg}	Storage temperature		$-40 \sim +125$	$^\circ C$
t_{psc}	Maximum short circuit pulse width	$V_{CC} = 2200V, V_{CE} \leq V_{CES}, V_{GE} = 15V, T_j = 125^\circ C$	10	μs

ELECTRICAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit	
			Min	Typ	Max		
I_{CES}	Collector cutoff current	$V_{CE} = V_{CES}, V_{GE} = 0V$	$T_j = 25^\circ C$	—	—	10	mA
			$T_j = 125^\circ C$	—	16	40	
$V_{GE(th)}$	Gate-emitter threshold voltage	$V_{CE} = 10V, I_C = 80 \text{ mA}, T_j = 25^\circ C$	5.0	6.0	7.0	V	
I_{GES}	Gate leakage current	$V_{GE} = V_{GES}, V_{CE} = 0V, T_j = 25^\circ C$	—	—	0.5	μA	
C_{ies}	Input capacitance	$V_{CE} = 10V, V_{GE} = 0V, f = 100 \text{ kHz}$ $T_j = 25^\circ C$	—	120	—	nF	
C_{oes}	Output capacitance		—	12	—	nF	
C_{res}	Reverse transfer capacitance		—	3.6	—	nF	
Q_g	Total gate charge	$V_{CC} = 1650V, I_C = 800 \text{ A}$ $V_{GE} = \pm 15V, T_j = 25^\circ C$	—	10	—	μC	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_C = 800 \text{ A}$ (Note 4) $V_{GE} = 15V$	$T_j = 25^\circ C$	—	3.30	—	V
			$T_j = 125^\circ C$	—	3.60	—	
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 1650V, I_C = 800 \text{ A}$ $V_{GE} = \pm 15V, R_G = 2.5 \Omega$ $T_j = 125^\circ C, L_s = 100 \text{ nH}$	—	—	1.60	μs	
t_r	Turn-on rise time		—	—	1.00	μs	
$E_{on(10\%)}$	Turn-on switching energy (Note 5)		Inductive load	—	1.10	—	J/P
$t_{d(off)}$	Turn-off delay time	$V_{CC} = 1650V, I_C = 800 \text{ A}$ $V_{GE} = \pm 15V, R_G = 2.5 \Omega$ $T_j = 125^\circ C, L_s = 100 \text{ nH}$	—	—	2.50	μs	
t_f	Turn-off fall time		—	—	1.00	μs	
$E_{off(10\%)}$	Turn-off switching energy (Note 5)		Inductive load	—	1.05	—	J/P
V_{EC}	Emitter-collector voltage (Note 2)	$I_E = 800 \text{ A}$ (Note 4) $V_{GE} = 0V$	$T_j = 25^\circ C$	—	2.80	—	V
			$T_j = 125^\circ C$	—	2.70	—	
t_{rr}	Reverse recovery time (Note 2)	$V_{CC} = 1650V, I_E = 800 \text{ A}$ $V_{GE} = \pm 15V, R_G = 2.5 \Omega$ $T_j = 125^\circ C, L_s = 100 \text{ nH}$	—	—	1.40	μs	
Q_{rr}	Reverse recovery charge (Note 2)		—	540	—	μC	
$E_{rec(10\%)}$	Reverse recovery energy (Note 2)(Note 5)		Inductive load	—	0.60	—	J/P

THERMAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
$R_{th(j-c)Q}$	Thermal resistance	Junction to Case, IGBT part	—	—	13.0	K/kW
$R_{th(j-c)R}$	Thermal resistance	Junction to Case, FWDi part	—	—	25.0	K/kW
		Junction to Case, Clamp-Di part	—	—	25.0	K/kW
$R_{th(c-f)}$	Contact thermal resistance	Case to Fin, $\lambda_{grease} = 1W/m\cdot K$, $D_{(c-f)} = 100 \mu m$	—	8.0	—	K/kW

MECHANICAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
M_t	Mounting torque	M8: Main terminals screw	7.0	—	13.0	N·m
M_s		M6: Mounting screw	3.0	—	6.0	N·m
M_t		M4: Auxiliary terminals screw	1.0	—	2.0	N·m
m	Mass		—	1.5	—	kg
CTI	Comparative tracking index		600	—	—	—
d_a	Clearance		19.5	—	—	mm
d_s	Creepage distance		32.0	—	—	mm
$L_{P\ CE}$	Parasitic stray inductance	Collector to Emitter	—	18	—	nH
$L_{P\ AK}$		Anode to Cathode	—	24	—	
R_{CC+EE}	Internal lead resistance	$T_c = 25^\circ C$, Collector to Emitter	—	0.20	—	m Ω
R_{AA+KK}		$T_c = 25^\circ C$, Anode to Cathode	—	0.30	—	

Note 1. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{opmax} rating (125°C).

Note 2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi) and the brake chopper, anode to cathode clamp diode (Clamp-Di).

Note 3. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).

Note 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

Note 5. $E_{on(10\%)} / E_{off(10\%)} / E_{rec(10\%)}$ are the integral of $0.1V_{CE} \times 0.1I_C \times dt$.

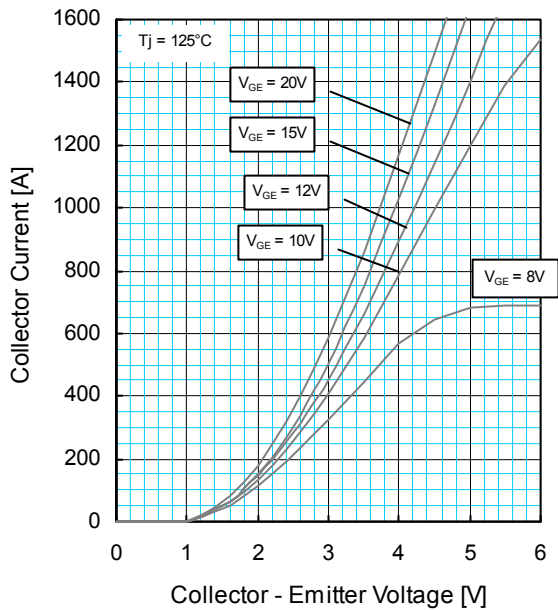
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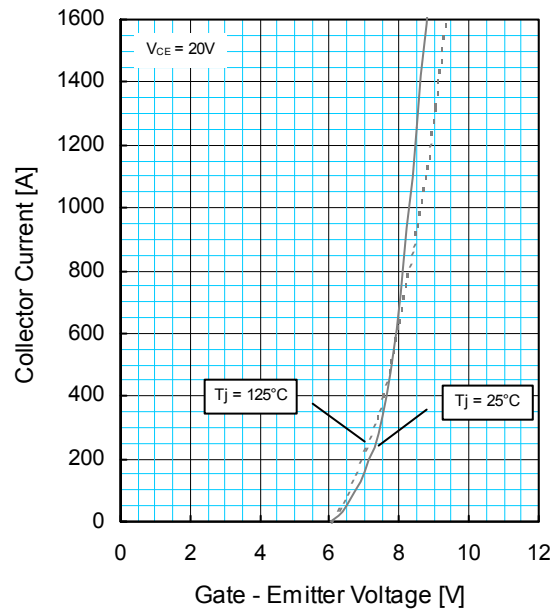
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PERFORMANCE CURVES

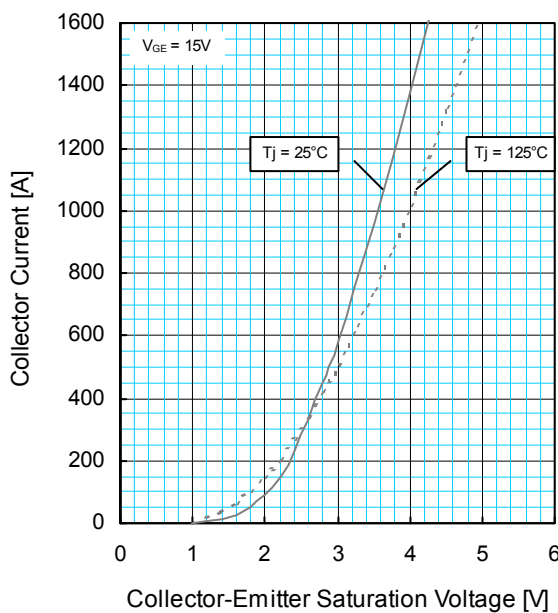
OUTPUT CHARACTERISTICS (TYPICAL)



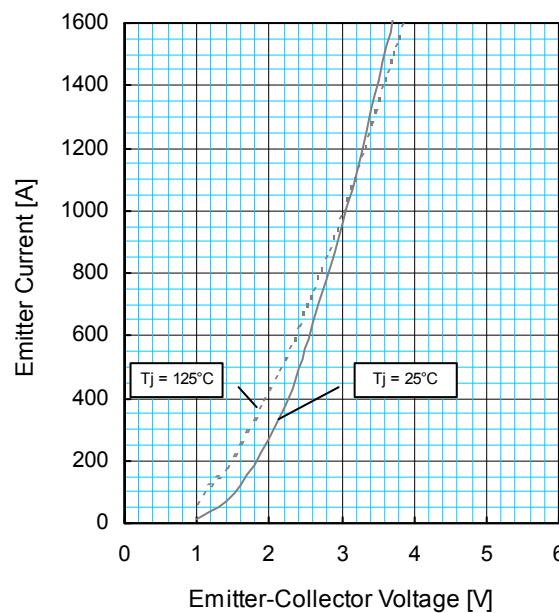
TRANSFER CHARACTERISTICS (TYPICAL)



COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



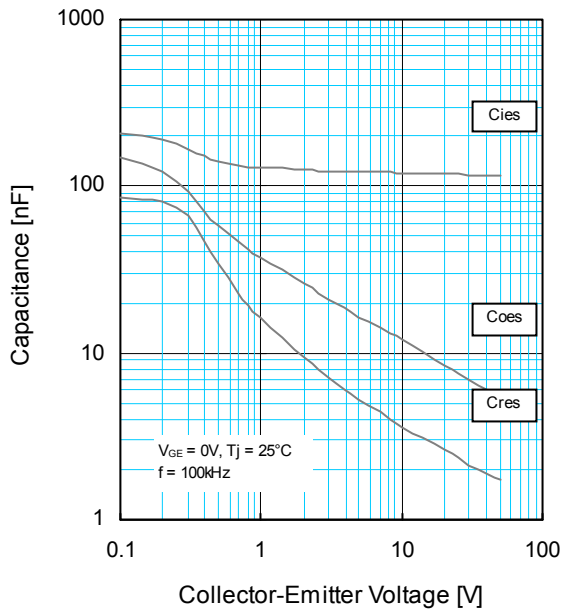
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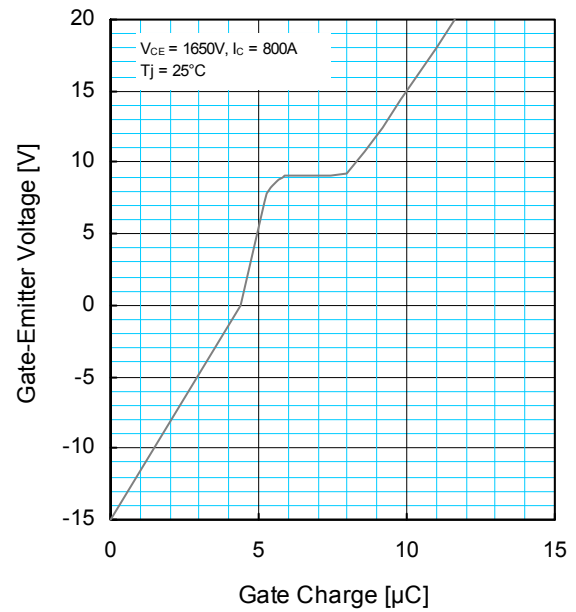
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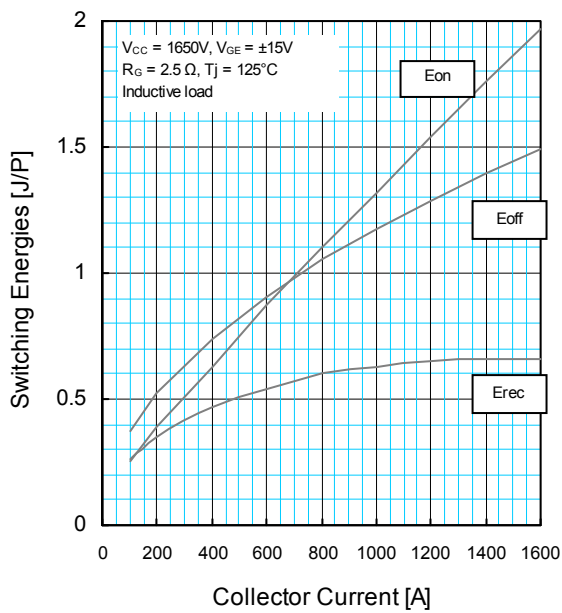
CAPACITANCE CHARACTERISTICS (TYPICAL)



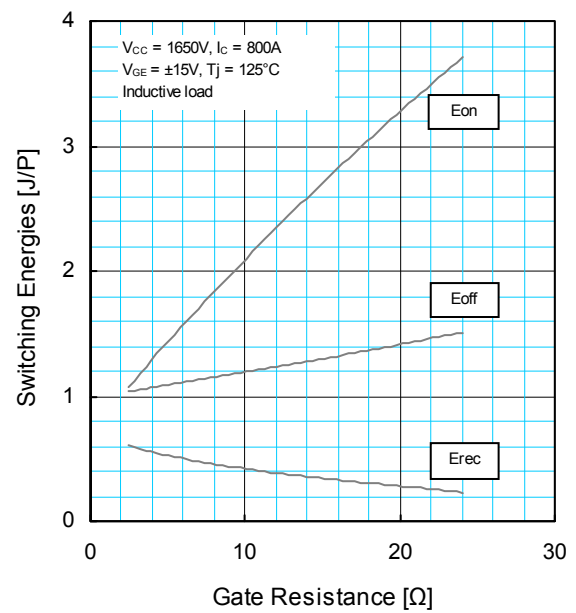
GATE CHARGE CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



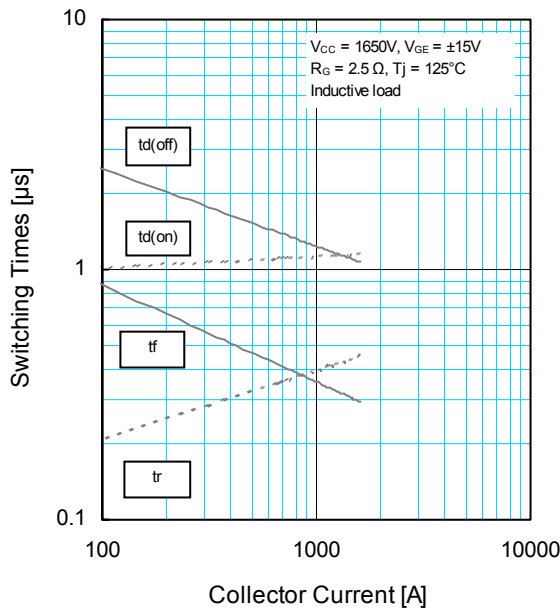
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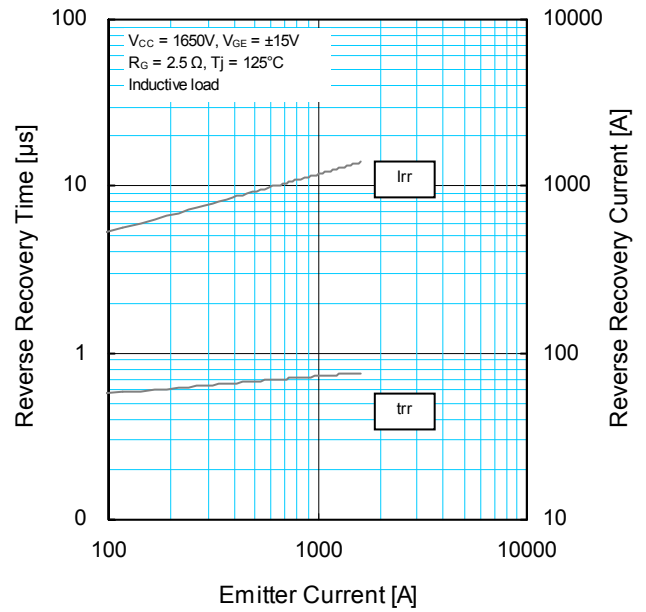
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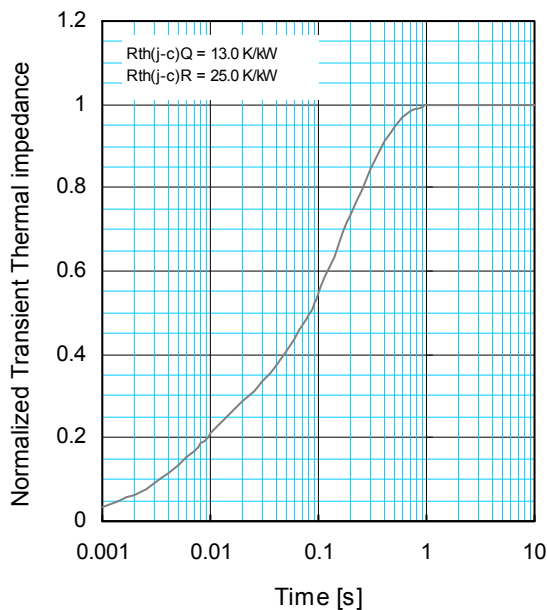
HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



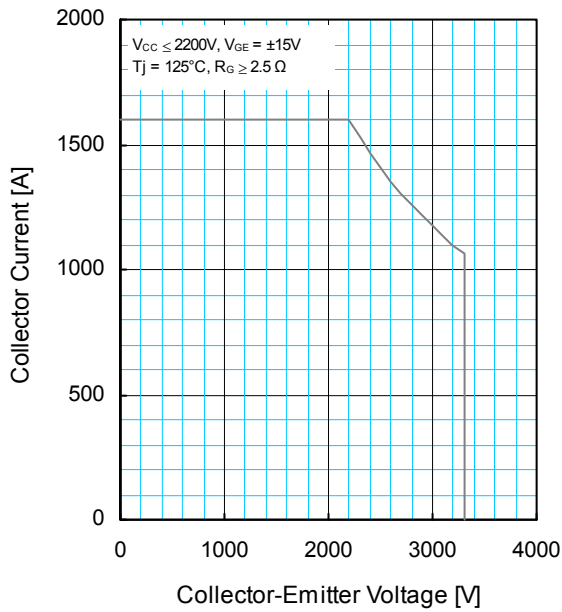
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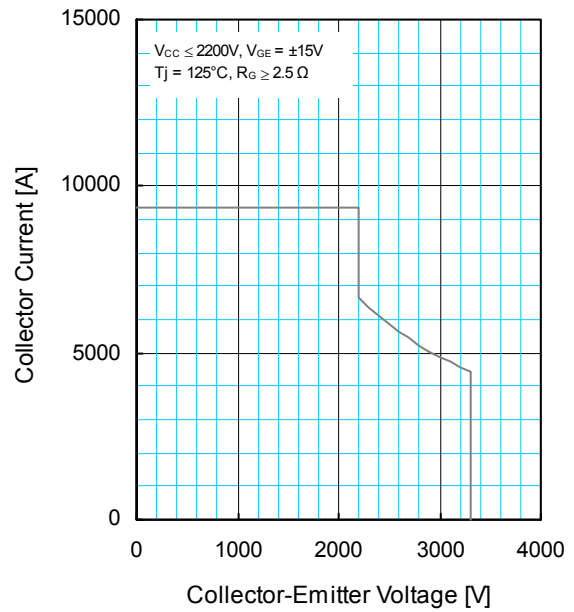
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PERFORMANCE CURVES

REVERSE BIAS SAFE OPERATING AREA (RBSOA)



SHORT CIRCUIT SAFE OPERATING AREA (SCSOA)



FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)

